

https://www.phoenixcontact.com/us/products/1332195

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SMD male connector, nominal current: 0.5 A, Test voltage: 500 V AC, number of positions: 20, pitch: 0.635 mm, color: black, contact surface: Gold, contact connection type: Pin, mounting: SMD soldering



### Your advantages

- · Design-in support during device development through M-CAD/E-CAD data and a free sample service
- · Cost and space savings with the comprehensive portfolio available in various stack heights
- · Easy mating with integrated keyways and tolerance compensation for error-free production
- · Time savings during the development process with customer-specific simulations for data integrity
- High-speed data transmission up to 30 Gbps for various possible applications

### Commercial data

Item number	1332195
Packing unit	540 pc
Minimum order quantity	540 pc
Sales key	AA23
Product key	AAWGCC
GTIN	4063151628758
Weight per piece (including packing)	1.337 g
Weight per piece (excluding packing)	1.337 g
Customs tariff number	85366930
Country of origin	CN

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### Technical data

### Product properties

Product type	SMD male connector
Product family	FS 0,635/MV-R- 9,0
Number of positions	20
Pitch	0.635 mm
Number of rows	2
Pin layout	Linear pad geometry

#### **Electrical properties**

Nominal current I <sub>N</sub>	0.5 A (40-pos. / 60-pos.)
Degree of pollution	3
Contact resistance	70 mΩ
Test voltage	500 V AC IEC 60512-4-1:2003
Rated voltage (I/1)	125 V
Rated surge voltage (I/1)	0.8 kV

#### Mounting

Mounting type SMD s	soldering
Pin layout Linear	pad geometry

Process	Reflow soldering
Moisture Sensitive Level	MSL 1
Classification temperature $T_{c}$	260 °C
Solder cycles in the reflow	3

#### Material specifications

#### Material data - contact

Note	WEEE/RoHS-compliant, free of whiskers according to IEC 60068-2-82/JEDEC JESD 201
Contact material	Cu alloy
Surface characteristics	Selective coating
Metal surface contact area (top layer)	Gold (Au)
Metal surface contact area (middle layer)	Nickel (Ni)
Metal surface soldering area (top layer)	Tin (Sn)
Metal surface soldering area (middle layer)	Nickel (Ni)
Material data - housing	
Color (Housing)	black (9005)
Insulating material	LCP

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Notes on operation	The permissible voltage during operation depends on the application, taking into consideration the air clearances and creepage distances within the scope of insulation requirements in accordance with IEC 60664-1.
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#### Dimensions

Dimensions	
Dimensional drawing	h P
Pitch	0.635 mm
Width [w]	13.22 mm
Height [h]	9.6 mm
Length [I]	5.2 mm
Installed height	9 mm
Application	
Contact cover	0.6 mm
Center offset	± 0.5 mm in longitudinal and transverse direction
Stack height	10 mm Tolerance: +0.6 mm (in combination with Range of articles:FS 0,635/FV-R- 4,0)
	16 mm Tolerance: +0.6 mm (in combination with Range of articles:FS 0,635/FV-R-10,0)
Wipe length	0.6 mm
Angular tolerance	$\pm$ 10 $^{\circ}$ in longitudinal and transverse direction (when plugging in)
	$\pm$ 2 $^{\circ}$ in longitudinal and transverse direction (when plugged in)
PCB design	
Pad geometry	0.35 x 1.8 mm
Hole diameter	0.9 mm
Electrical tests	
Thermal test   Test group C	
Specification	IEC 60512-5-2:2002-02
Tested number of positions	60
Insulation resistance	

Specification	IEC 60512-3-1:2002-02
Insulation resistance, neighboring positions	≥ 5 GΩ
Air clearances and creepage distances	
Air clearances and creepage distances   Specification	IEC 60664-1:2007-04

Environmental and real-life conditions



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Specification	IEC 60068-2-6:2007-12
Frequency	10 - 55 - 10 Hz
Sweep speed	1 octave/min
Amplitude	1.52 mm
Sweep speed	181 m/s²
Test duration per axis	2 h
urability test	
Specification	IEC 60512-9-1:2010-03 (following)
Contact resistance R <sub>1</sub>	70 mΩ
Contact resistance R <sub>2</sub>	70 mΩ
Insertion/withdrawal cycles	50
Insulation resistance, neighboring positions	≥ 5 GΩ
limatic test	
Specification	IEC 60068-2-60:2015-06
Corrosive stress	Method 4, 10 days
Thermal stress	125 °C/168 h
Power-frequency withstand voltage	500 V
mbient conditions	
Ambient temperature (operation)	-55 °C 125 °C
Ambient temperature (storage/transport)	-40 °C 70 °C
Relative humidity (storage/transport)	30 % 70 %
Ambient temperature (assembly)	-5 °C 100 °C
kaging specifications	
Dimensional drawing	
Dimensional drawing	
Type of packaging	32 mm wide tape
[W] tape width	32 mm

32 mm
38.4 mm
330 mm
Transparent-Bag
(D) electrostatically conductive
DIN EN 61340-5-1 (VDE 0300-5-1): 2008-07

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### Classifications

#### ECLASS

ECLASS-11.0	27460201
ECLASS-12.0	27460201
ECLASS-13.0	27460201

#### ETIM

	ETIM 9.0	EC002637			
UN	UNSPSC				
	UNSPSC 21.0	39121400			

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### Environmental product compliance

China RoHS	Environmentally friendly use period: unlimited = EFUP-e
	No hazardous substances above threshold values

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